

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT5268627

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KYUNG SOO MOON	11/07/2018
JAEHYUN KIM	11/07/2018
YOONG HEE NA	11/07/2018
RAN NAMGUNG	11/07/2018
HWANSUNG CHEON	11/07/2018
SEUNGYONG CHAE	11/07/2018
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16211114
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ATTORNEY DOCKET NUMBER:	162023 JEJ/CLM
NAME OF SUBMITTER:	CHRISTINA L. MALINOSKY
SIGNATURE:	/Christina L. Malinosky/
DATE SIGNED:	12/05/2018
Total Attachments: 3	

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**INVENTOR'S DECLARATION AND ASSIGNMENT
FOR PATENT APPLICATION**

PATENT

Title of Invention: SEMICONDUCTOR RESIST COMPOSITION, AND METHOD OF
FORMING PATTERNS USING THE COMPOSITION
Docket No.: 162023

INVENTOR'S DECLARATION

As a below named inventor, I hereby declare that:

This declaration is directed to the attached application unless the following is checked:

___ United States Application or PCT International Application Number _____
filed on _____.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the above-identified application.

I have reviewed and understand the contents of the above-identified application, including the claims.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 C.F.R. § 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

I acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both.

ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned,

(1) Kyung Soo MOON, Jaehyun KIM, Yoong Hee NA, Ran NAMGUNG, Hwansung CHEON,
and Seungyong CHAE

HEREBY SELL(S), ASSIGN(S) AND TRANSFER(S) TO

(2) SAMSUNG SDI CO., LTD.

having a place of business at

(3) 150-20 Gongse-ro, Giheung-gu, Yongin-si, Gyeonggi-do 17084, Republic of Korea

(hereinafter called "ASSIGNEE") the entire right, title and interest in and to any and all improvements which are disclosed in the application for United States Letters Patent entitled

(4) SEMICONDUCTOR RESIST COMPOSITION, AND METHOD OF FORMING PATTERNS
USING THE COMPOSITION

INVENTOR'S DECLARATION AND ASSIGNMENT
FOR PATENT APPLICATION

Docket No.: 162023

which application executed on even date
herewith or was

(a) executed on (5a): _____;
(b) filed on (5b): December 5, 2018;
Application No.: 16/211,114;

(LEWIS ROCA ROTHGERBER CHRISTIE
LLP, P.O. Box 29001, Glendale, CA 91209-
9001) is hereby authorized to insert in (b) the
specified data, when known.

including any and all United States Patents which may be granted on said application, and any
and all extensions, divisions, reissues, substitutes, renewals or continuations of said application
and patents, and the right to all benefits under all international conventions for the protection of
industrial property and applications for said improvements.

It is hereby authorized and requested that the Commissioner of Patents issue any and all of said
Letters Patent, when granted, to said ASSIGNEE, its assigns or its successors in interest or its
designee.

Upon said consideration, it is further agreed that, when requested, without charge to but at the
expense of said ASSIGNEE, the undersigned will execute all divisional, continuing, substitute,
renewal, and reissue patent applications; execute all rightful other papers; and generally do
everything possible which said ASSIGNEE shall consider desirable for aiding in securing and
maintaining patent protection as provided herein.

Kyung Soo MOON

Legal Name of Inventor

Date

Nov. 7, 2018

Signature

Jaehyun KIM

Legal Name of Inventor

Date

Nov 7, 2018

Signature

Yoong Hee NA

Legal Name of Inventor

Date

Nov. 7, 2018

Signature

INVENTOR'S DECLARATION AND ASSIGNMENT
FOR PATENT APPLICATION

Docket No.: 162023

Ran NAMGUNG

Legal Name of Inventor

Signature

Date

Nov. 7. 2018

Hwansung CHEON

Legal Name of Inventor

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Date

Nov. 7. 2018

Seungyong CHAE

Legal Name of Inventor

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Nov. 7. 2018

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